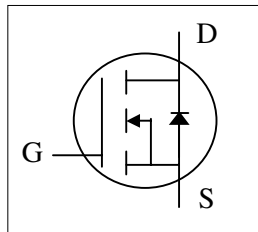




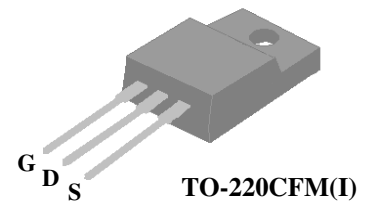
- ▼ 100% Avalanche Test
- ▼ Single Drive Requirement
- ▼ Fast Switching Characteristic



$BV_{DSS}$	100V
$R_{DS(ON)}$	36m $\Omega$
$I_D$	40A

## Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.



The TO-220CFM isolation package is widely preferred for commercial-industrial through hole applications.

## Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	100	V
$V_{GS}$	Gate-Source Voltage	+20	V
$I_D@T_C=25^\circ C$	Continuous Drain Current, $V_{GS}$ @ 10V	40	A
$I_D@T_C=100^\circ C$	Continuous Drain Current, $V_{GS}$ @ 10V	27	A
$I_{DM}$	Pulsed Drain Current <sup>1</sup>	150	A
$P_D@T_C=25^\circ C$	Total Power Dissipation	37.5	W
$T_{STG}$	Storage Temperature Range	-55 to 175	$^\circ C$
$T_J$	Operating Junction Temperature Range	-55 to 175	$^\circ C$

## Thermal Data

Symbol	Parameter	Value	Units
Rthj-c	Maximum Thermal Resistance, Junction-case	4.0	$^\circ C/W$
Rthj-a	Maximum Thermal Resistance, Junction-ambient	65	$^\circ C/W$



## Electrical Characteristics@T<sub>j</sub>=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =1mA	100	-	-	V
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V, I <sub>D</sub> =15A	-	-	36	mΩ
		V <sub>GS</sub> =6V, I <sub>D</sub> =10A	-	-	42	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	2	-	4	V
g <sub>fs</sub>	Forward Transconductance	V <sub>DS</sub> =15V, I <sub>D</sub> =15A	-	14.5	-	S
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V	-	-	25	uA
	Drain-Source Leakage Current (T <sub>j</sub> =125°C)	V <sub>DS</sub> =80V, V <sub>GS</sub> =0V	-	-	100	uA
I <sub>GSS</sub>	Gate-Source Leakage	V <sub>GS</sub> =±20V	-	-	±100	nA
Q <sub>g</sub>	Total Gate Charge <sup>2</sup>	I <sub>D</sub> =40A	-	24	40	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DS</sub> =50V	-	5.4	-	nC
Q <sub>gd</sub>	Gate-Drain ("Miller") Charge	V <sub>GS</sub> =10V	-	9.6	-	nC
t <sub>d(on)</sub>	Turn-on Delay Time <sup>2</sup>	V <sub>DS</sub> =50V	-	9	-	ns
t <sub>r</sub>	Rise Time	I <sub>D</sub> =40A	-	64	-	ns
t <sub>d(off)</sub>	Turn-off Delay Time	R <sub>G</sub> =2.5Ω, V <sub>GS</sub> =10V	-	19	-	ns
t <sub>f</sub>	Fall Time	R <sub>D</sub> =1.25Ω	-	75	-	ns
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V	-	1310	2100	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =25V	-	270	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f=1.0MHz	-	85	-	pF

## Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V <sub>SD</sub>	Forward On Voltage <sup>2</sup>	I <sub>S</sub> =15A, V <sub>GS</sub> =0V	-	-	1.2	V
t <sub>rr</sub>	Reverse Recovery Time <sup>2</sup>	I <sub>S</sub> =30A, V <sub>GS</sub> =0V,	-	60	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	di/dt=100A/μs	-	125	-	nC

### Notes:

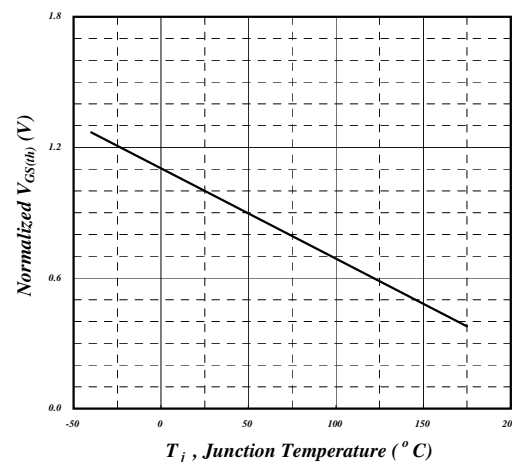
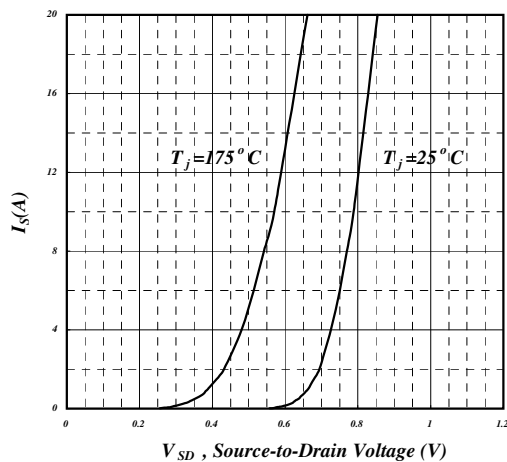
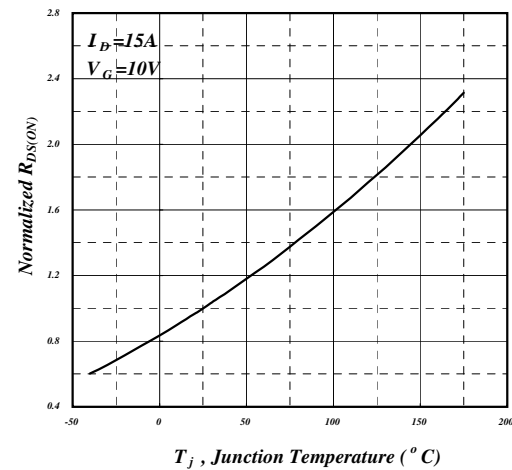
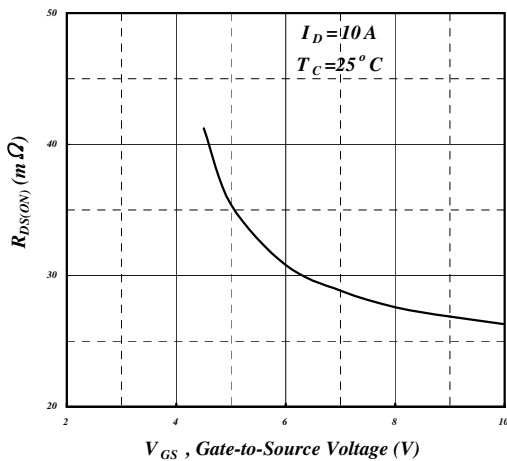
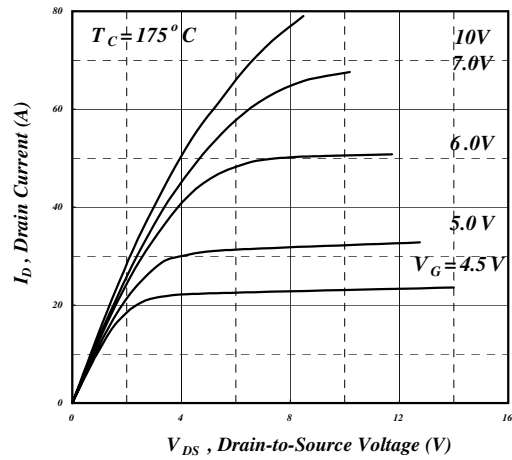
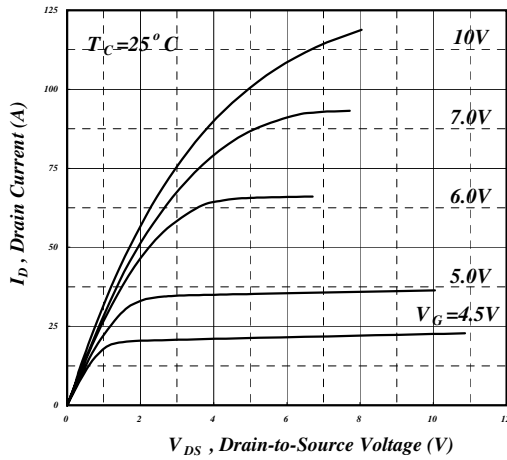
- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

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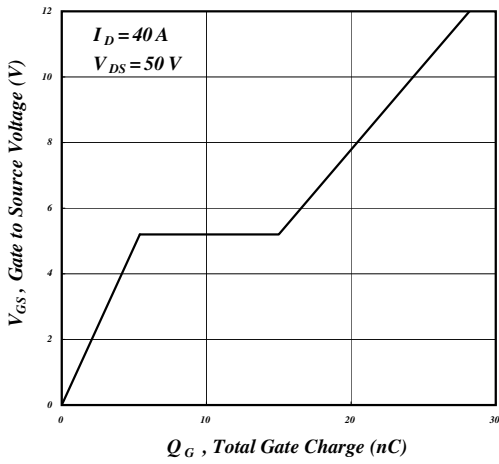


Fig 7. Gate Charge Characteristics

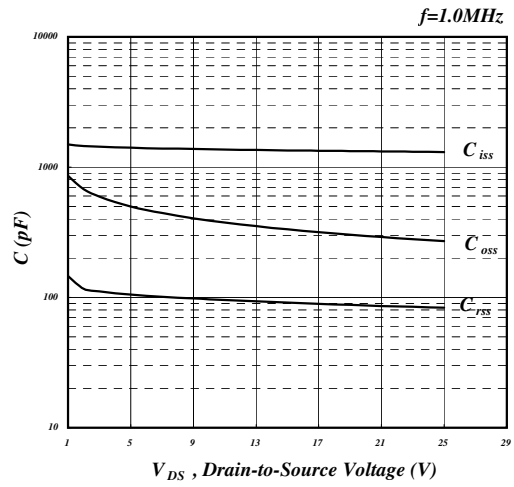


Fig 8. Typical Capacitance Characteristics

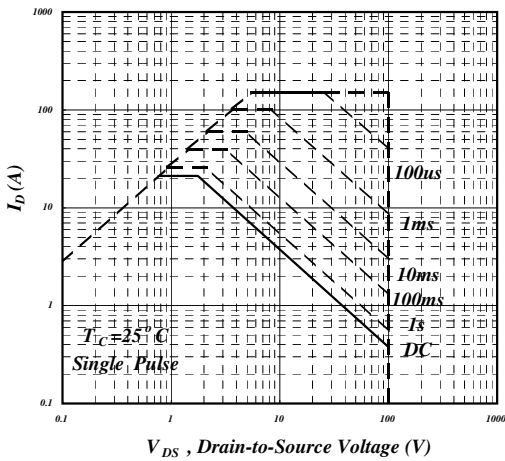


Fig 9. Maximum Safe Operating Area

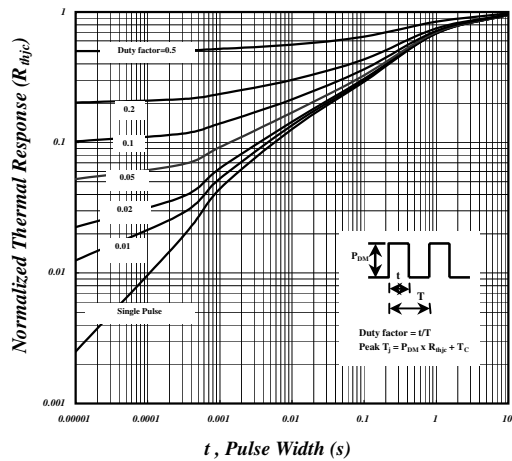


Fig 10. Effective Transient Thermal Impedance

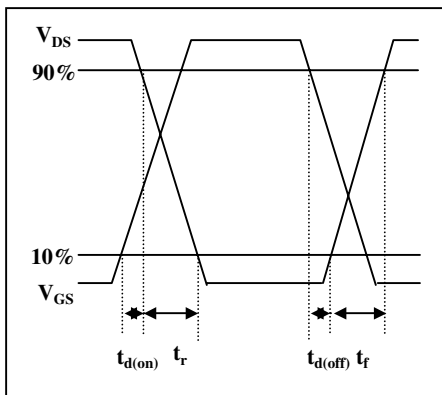


Fig 11. Switching Time Waveform

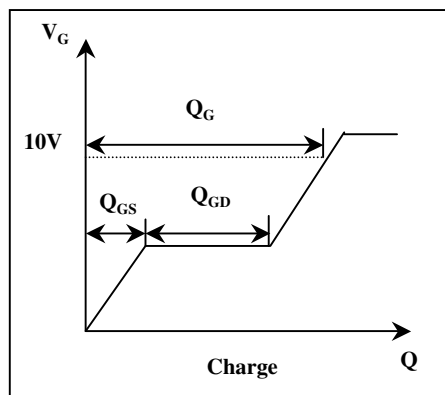


Fig 12. Gate Charge Waveform